© Copyright 20	mposition De 05. IPC, Bannockt 1 Pan-American co	ourn, Illinois. A	ll rights reserved u ntions.	nder both	This docume level parts, t	ent is a declara he declaration	ion of the s encompasse	ubstances es all lower	within the manufactur level materials for w	rer listed i hich the n	tem. Note: i nanufacturer	f the item is an as r has engineering	sembly with lower responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Tyj http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				als and Mfg Information				
Supplier Information													
Company name* Compa			Company unique ID			Unique ID Authority				Response Date*			
onsemi										2025-05-14			
Contact Name Title - Co			tle - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product			roduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Re			- Representative			Phone - Representative*				Email - Representative*			
Product-Env-Stewards Product			roduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	e Version	N	Ianufacturing Site		Weight*	UOM	Unit Type
	MBRA1	MBRA1H100T3G 1 A, 100		A, 100 V SCHOTTKY RECT		2025-05-14		V	VN5		76.66	mg	Each
Manufacturing Proccess Infor	mation						-						
Terminal Plating / Grid Arra	Terminal Plating / Grid Array Material Terminal Base		Alloy J	-STD-020 MSI	L Rating	Peak Pro	ess Body T	emperatur	e Max Time at Peak	Temperat	ure Numb	per of Reflow Cyc	eles
Matte Tin (Sn) - annealed CU Alloy		1	1		260		С	30	secon	ds 3			
Comments													
evel 1 - maximum time at peak tempe	erature during so	ldering is 10-3	0 seconds										
For more information regarding mate	rial composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (Pl		dmium and quantity limit of 0.1% by mass (10 minated Diphenyl Ethers (PBDE), and Bis(2-et	
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).		
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the
Supplier Digital Signature	astislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	7.0	mg	Supplier	Zinc (Zn)	7440-66-6		0.014	mg
			В	Nickel (Ni)	7440-02-0		0.0252	mg
			Supplier	Iron (Fe)	7439-89-6		0.1778	mg
			Supplier	Copper (Cu)	7440-50-8		6.7725	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0105	mg
Die	1.12	mg	Supplier	Silicon (Si)	7440-21-3		1.12	mg
Die Attach Solder	3.45	mg	Supplier	Silver (Ag)	7440-22-4		0.0862	mg
			А	Lead (Pb)	7439-92-1	7a	3.1913	mg
			Supplier	Tin (Sn)	7440-31-5		0.1725	mg
Lead Frame	28.84	mg	Supplier	Zinc (Zn)	7440-66-6		0.0346	mg
			Supplier	Iron (Fe)	7439-89-6		0.6922	mg
			Supplier	Copper (Cu)	7440-50-8		28.0902	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0231	mg
Mold Compound-Black	34.87	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		3.487	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1743	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		5.0561	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		22.6655	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		3.487	mg
Plating	1.38	mg	Supplier	Tin (Sn)	7440-31-5		1.38	mg